



BR93G66FJ-3BGTE2 Information



For Reference Only

Part NumberBR93G66FJ-3BGTE2ManufacturerRohm SemiconductorCategoryIntegrated Circuits (ICs)

Memory

Description MICROWIRE BUS 4KBIT(256X16BIT) E

Package 8-SOIC (0.154", 3.90mm Width)

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









BR93G66FJ-3BGTE2 Specifications

Manufacturer Part Number	BR93G66FJ-3BGTE2
Manufacturer	Rohm Semiconductor
Category	Integrated Circuits (ICs)
	Memory
Package	8-SOIC (0.154", 3.90mm Width)
Series	-
Memory Type	Non-Volatile
Memory Format	EEPROM
Technology	EEPROM
Memory Size	4Kb (256 x 16)
Memory Interface	SPI
Clock Frequency	3MHz
Write Cycle Time - Word, Page	5ms
Access Time	-
Voltage - Supply	1.7 V ~ 5.5 V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package	8-SOP-J
	Report errors?

BR93G66FJ-3BGTE2 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

BR93G66FJ-3BGTE2 Payment Methods





















BR93G66FJ-3BGTE2 Shipping Methods













If you have any question about BR93G66FJ-3BGTE2, please do not hesitate to contact us!

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